

No.3771A

2SK1470

## N-Channel MOS Silicon FET

## Very High-Speed Switching Applications

## Features

- Low ON resistance.
  - Very high-speed switching.
  - Low-voltage drive.

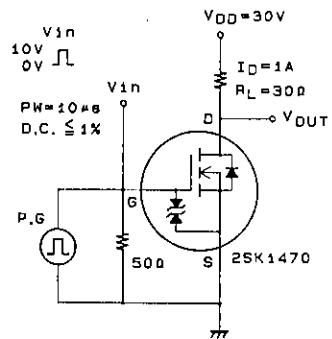
#### Absolute Maximum Ratings at $T_a = 25^\circ\text{C}$

		Unit
Drain to Source Voltage	V <sub>DSS</sub>	60 V
Gate to Source Voltage	V <sub>GSS</sub>	±15 V
Drain Current(DC)	I <sub>D</sub>	2 A
Drain Current(Pulse)	I <sub>DP</sub>	PW ≤ 10 μs, duty cycle ≤ 1% 8 A
Allowable Power Dissipation	P <sub>D</sub>	T <sub>c</sub> = 25°C Mounted on ceramic board (250mm <sup>2</sup> × 0.8mm) 3.5 W 1.5 W
Channel Temperature	T <sub>ch</sub>	150 °C
Storage Temperature	T <sub>stg</sub>	-55 to +150 °C

### Electrical Characteristics at Ta = 25°C

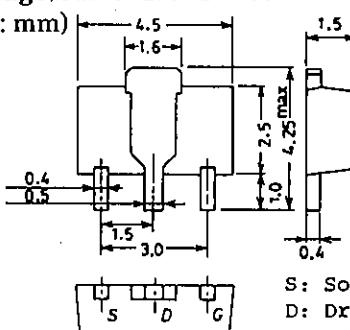
Electrical Characteristics at $T_a = 25^\circ C$			min	typ	max	unit
D-S Breakdown Voltage	$V_{(BR)DSS}$	$I_D = 1\text{mA}, V_{GS} = 0$		60		V
Zero Gate Voltage	$I_{DSS}$	$V_{DS} = 60\text{V}, V_{GS} = 0$			100	$\mu\text{A}$
Drain Current						
Gate to Source Leakage Current	$I_{GSS}$	$V_{GS} = \pm 12\text{V}, V_{DS} = 0$			$\pm 10$	$\mu\text{A}$
Cutoff Voltage	$V_{GS(\text{off})}$	$V_{DS} = 10\text{V}, I_D = 1\text{mA}$	1.0		2.0	V
Forward Transfer Admittance	$ Y_{fs} $	$V_{DS} = 10\text{V}, I_D = 1\text{A}$	1.2	2.0		S
Static Drain to Source	$R_{DS(\text{on})}$	$I_D = 1\text{A}, V_{GS} = 10\text{V}$		0.35	0.45	$\Omega$
on State Resistance	$R_{DS(\text{on})}$	$I_D = 1\text{A}, V_{GS} = 4\text{V}$		0.45	0.6	$\Omega$
Input Capacitance	$C_{iss}$	$V_{DS} = 20\text{V}, f = 1\text{MHz}$	150			pF
Output Capacitance	$C_{oss}$	$V_{DS} = 20\text{V}, f = 1\text{MHz}$	60			pF
Reverse Transfer Capacitance	$C_{rss}$	$V_{DS} = 20\text{V}, f = 1\text{MHz}$	12			pF
Turn-ON Delay Time	$t_{d(\text{on})}$	See specified Test Circuit.	6			ns
Rise Time	$t_r$	"		10		ns
Turn-OFF Delay Time	$t_{d(\text{off})}$	"		60		ns
Fall Time	$t_f$	"		20		ns
Diode Forward Voltage	$V_{SD}$	$I_S = 2\text{A}, V_{GS} = 0$		1.0		V

## **Switching Time Test Circuit**



## Package Dimensions 2062

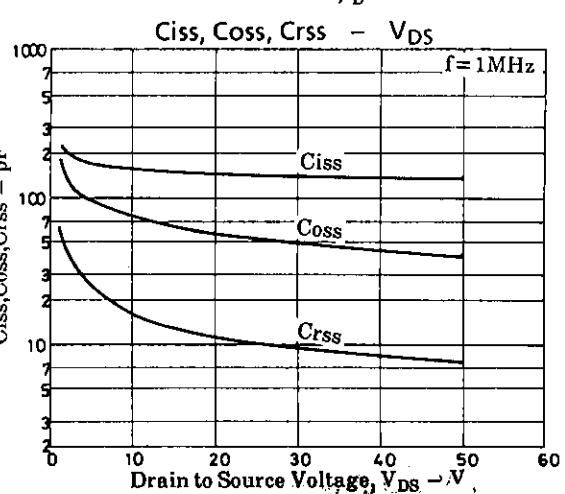
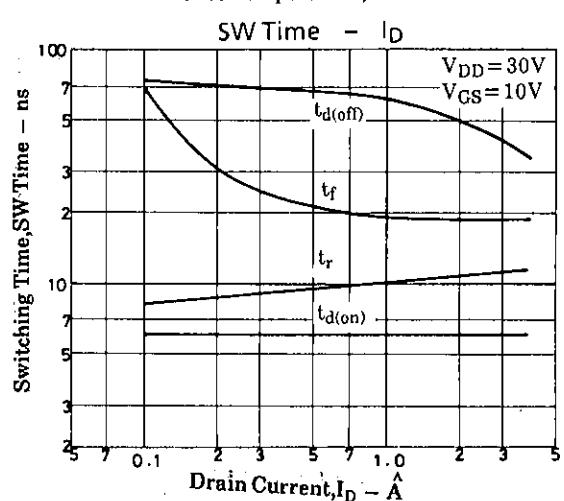
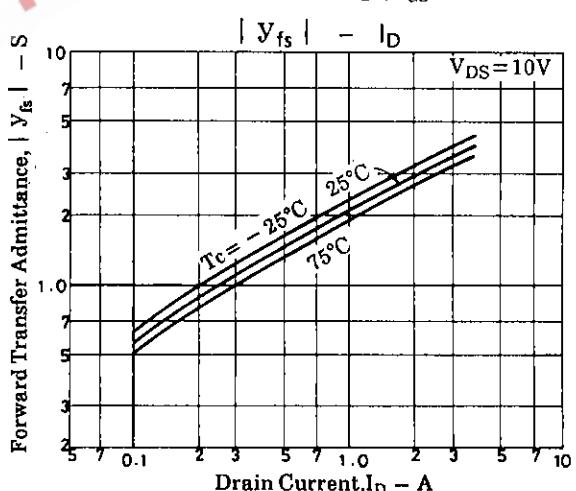
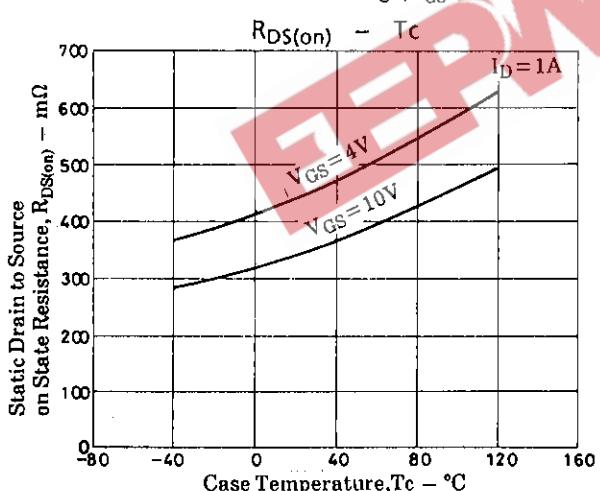
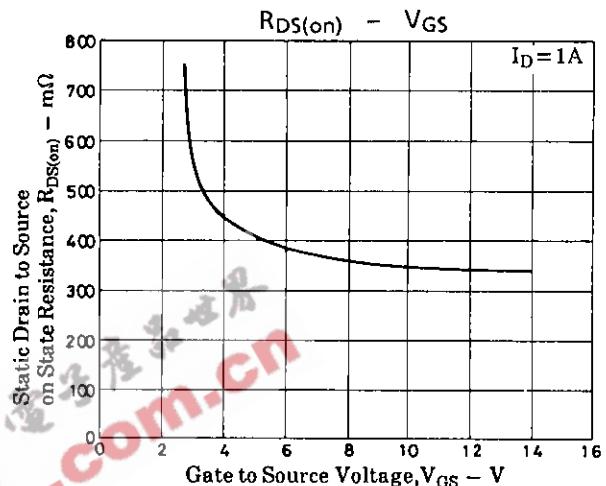
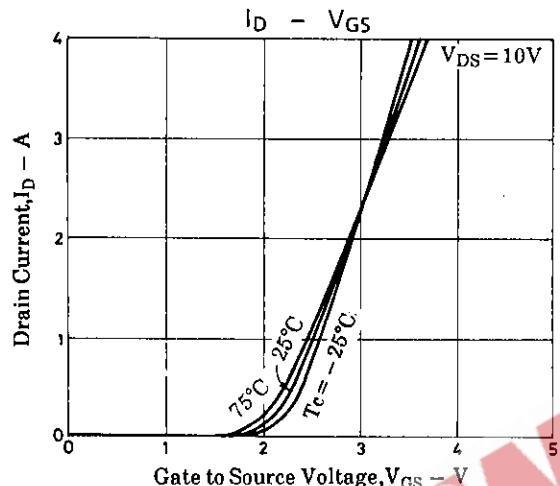
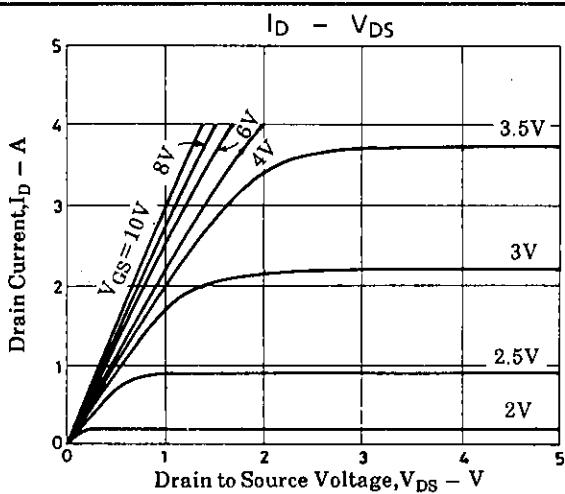
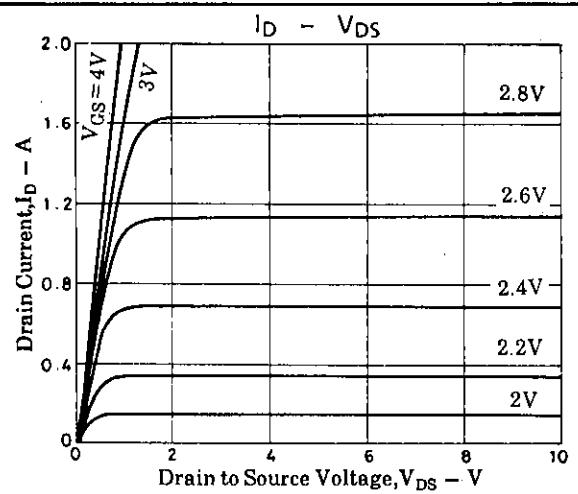
(unit: mm)

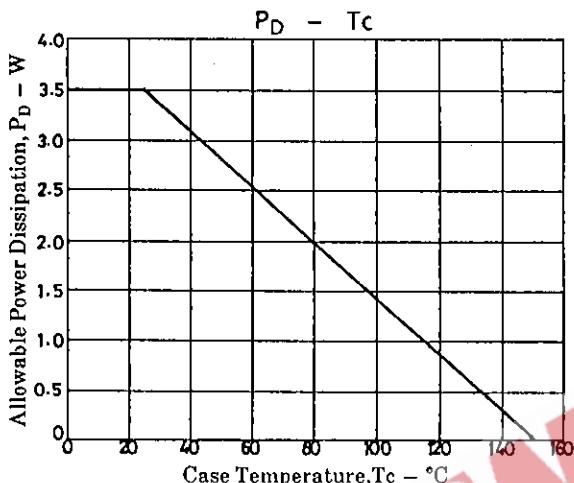
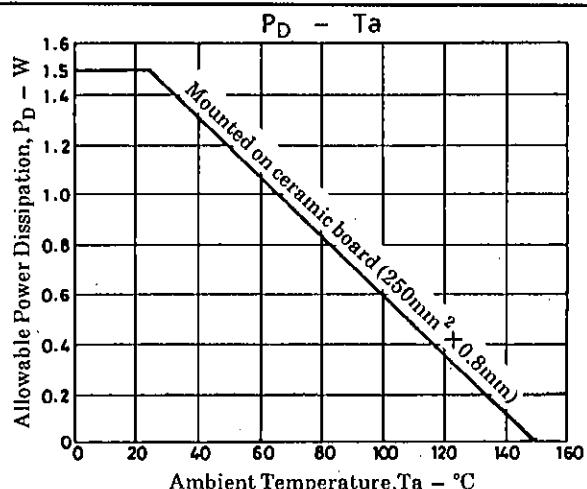
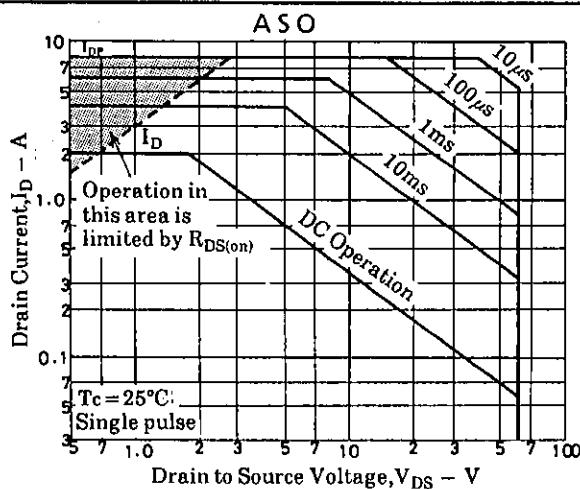


S: Source  
D: Drain  
G: Gate

SANYO: PCP

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